

# SHINDENGEN

## HVX-2 Series Power MOSFET

## N-Channel Enhancement type

**2SK2669**  
**(F5V90HVX2)**

**900V 5A**

## FEATURES

Input capacitance ( $C_{iss}$ ) is small.  
Especially, input capacitance  
at 0 bias is small.

The static Rds(on) is small.

The switching time is fast.

Avalanche resistance guaranteed.

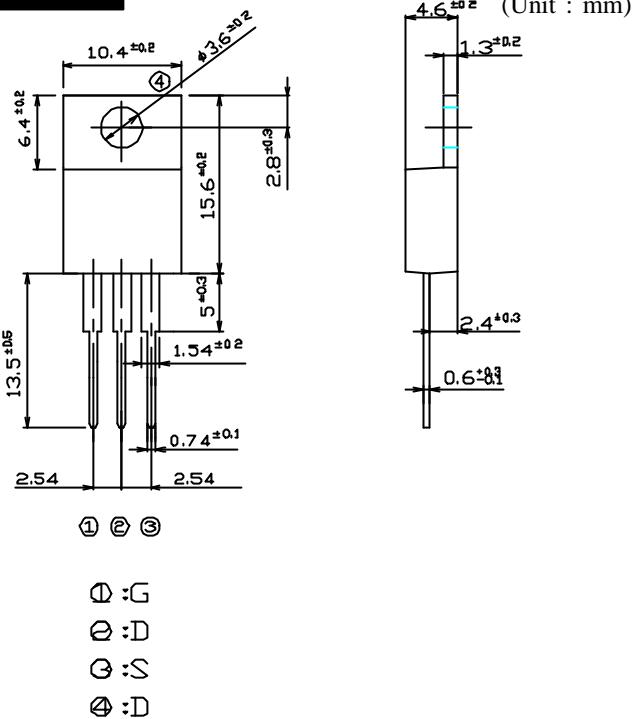
## APPLICATION

Switching power supply of AC 240V input  
High voltage power supply

## Inverter

## **OUTLINE DIMENSIONS**

Case : TO-220



# RATINGS

### Absolute Maximum Ratings ( $T_c = 25^\circ C$ )

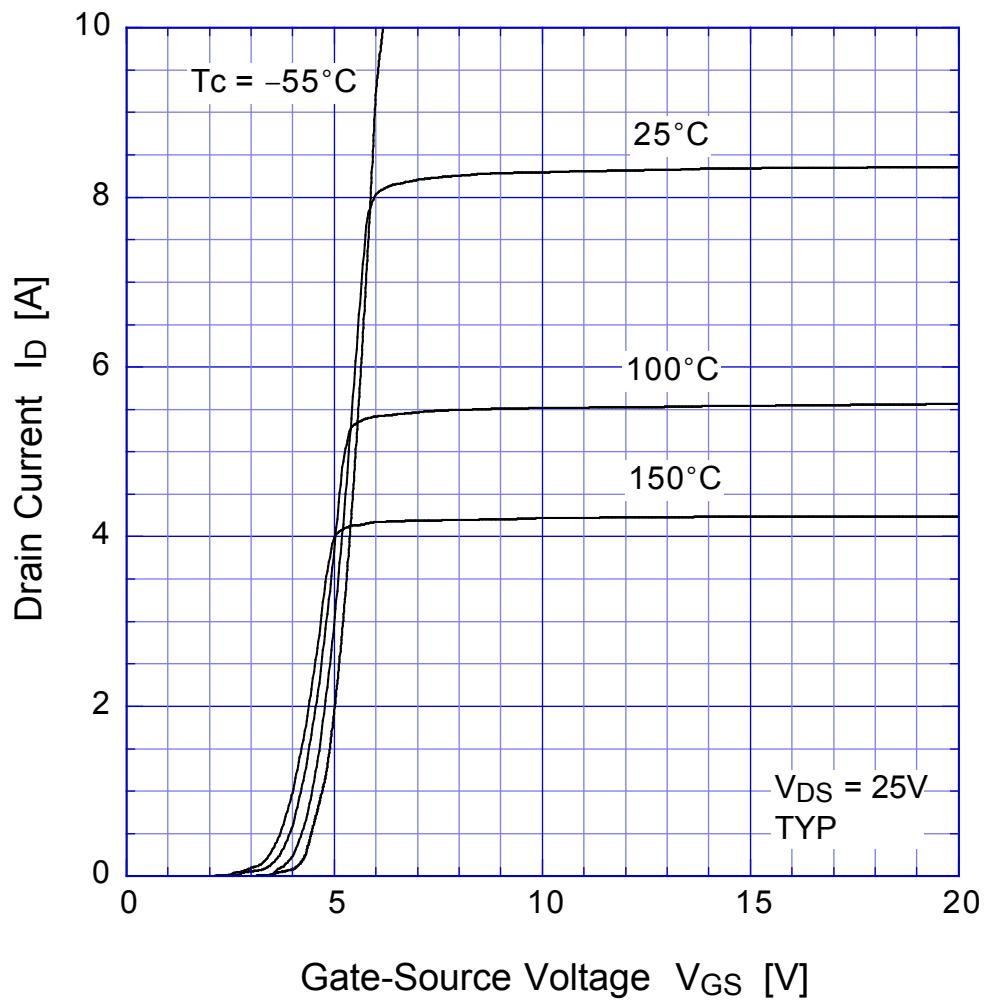
Item	Symbol	Conditions	Ratings	Unit
Storage Temperature	T <sub>STG</sub>		-55 ~ 150	
Channel Temperature	T <sub>CH</sub>		150	
Drain-Source Voltage	V <sub>DSS</sub>		900	V
Gate-Source Voltage	V <sub>GSS</sub>		± 30	
Continuous Drain Current (DC)	I <sub>D</sub>		5	
Continuous Drain Current (Peak)	I <sub>DP</sub>	Pulse width 10 μs, Duty cycle 1/100	10	A
Continuous Source Current (DC)	I <sub>S</sub>		5	
Total Power Dissipation	P <sub>T</sub>		60	W
Repetitive Avalanche Current	I <sub>AR</sub>	T <sub>CH</sub> = 150	5	A
Single Avalanche Energy	E <sub>AS</sub>	T <sub>CH</sub> = 25	100	mJ
Repetitive Avalanche Energy	E <sub>AR</sub>	T <sub>CH</sub> = 25	10	
Mounting Torque	T <sub>OR</sub>	(Recommended torque : 0.3 N·m )	0.5	N·m

●Electrical Characteristics T<sub>c</sub> = 25°C

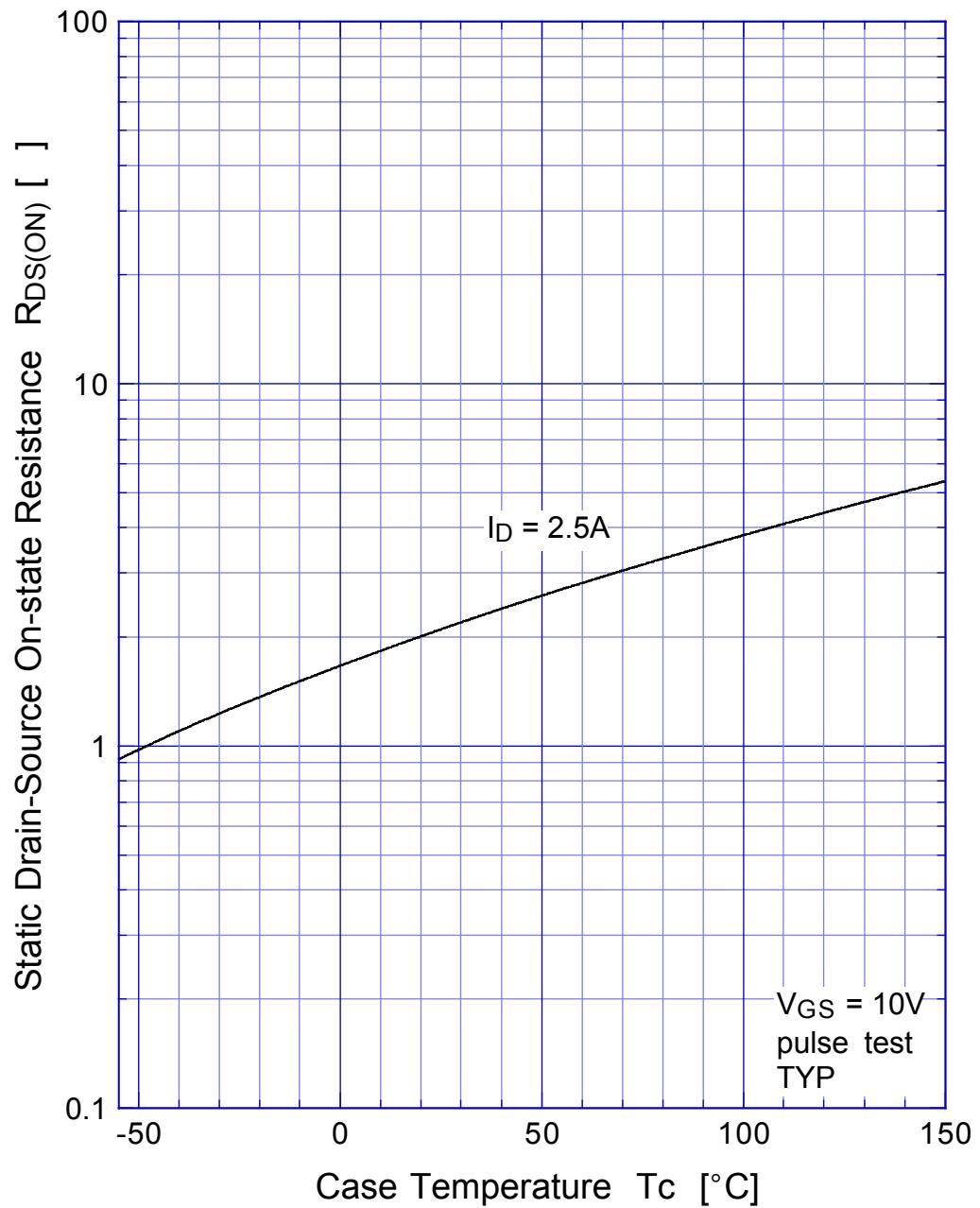
Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	ID = 1mA, VGS = 0V	900			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 900V, VGS = 0V			250	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	VGS = ±30V, VDS = 0V			±0.1	
Forward Transconductance	g <sub>fS</sub>	ID = 2.5A, VDS = 10V	2.4	4.0		S
Static Drain-Source On-state Resistance	R <sub>D(S)ON</sub>	ID = 2.5A, VGS = 10V		2.1	2.8	Ω
Gate Threshold Voltage	V <sub>TH</sub>	ID = 1mA, VDS = 10V	2.5	3.0	3.5	V
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2.5A, VGS = 0V			1.5	
Thermal Resistance	θ <sub>jc</sub>	junction to case			2.08	°C/W
Total Gate Charge	Q <sub>g</sub>	VGS = 10V, ID = 5A, VDD = 400V		45		nC
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25V, VGS = 0V, f = 1MHz		1140		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			23		
Output Capacitance	C <sub>oss</sub>			105		
Turn-On Time	t <sub>on</sub>	ID = 2.5A, VGS = 10V, RL = 60Ω		55	100	ns
Turn-Off Time	t <sub>off</sub>			210	350	

# 2SK2669

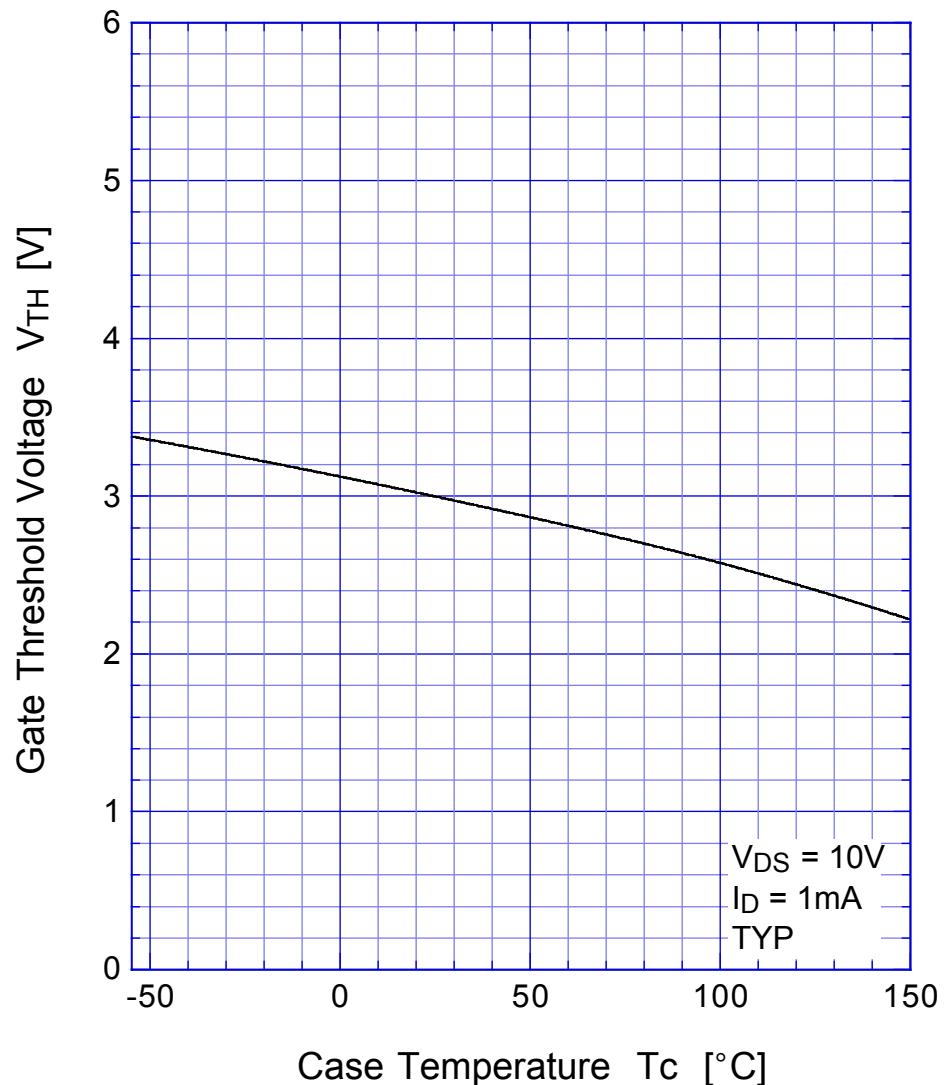
## Transfer Characteristics



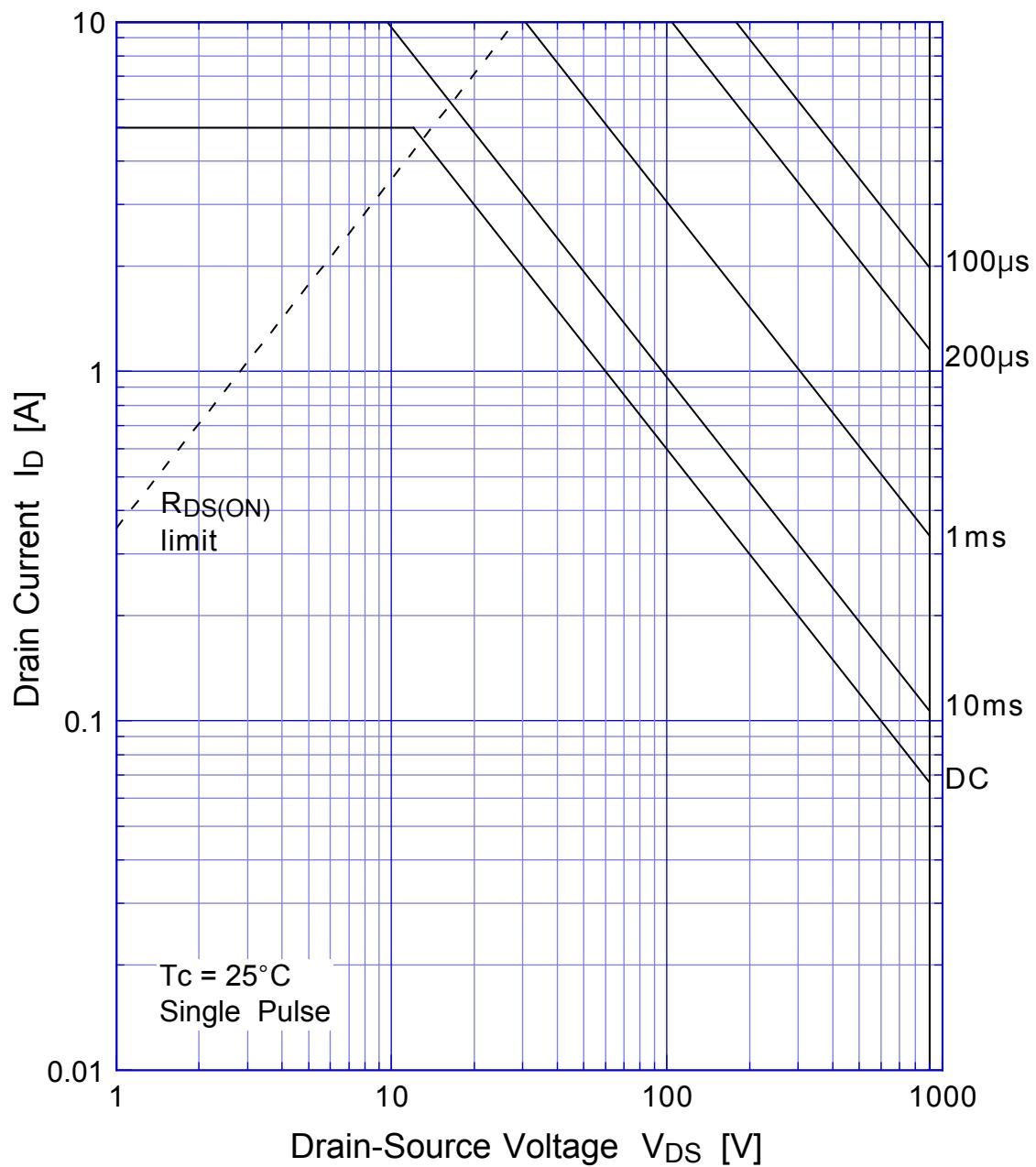
## **2SK2669 Static Drain-Source On-state Resistance**



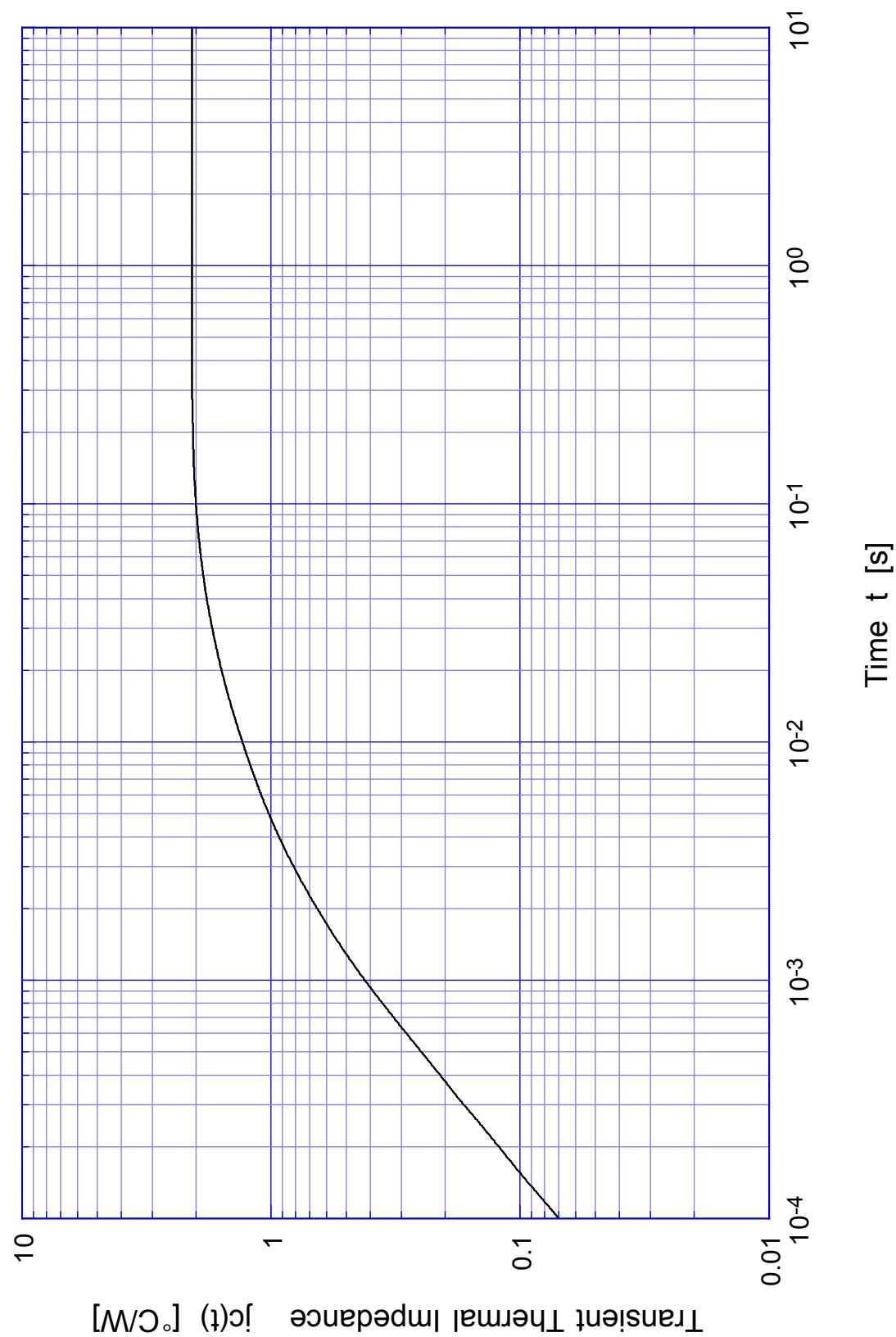
## 2SK2669 Gate Threshold Voltage



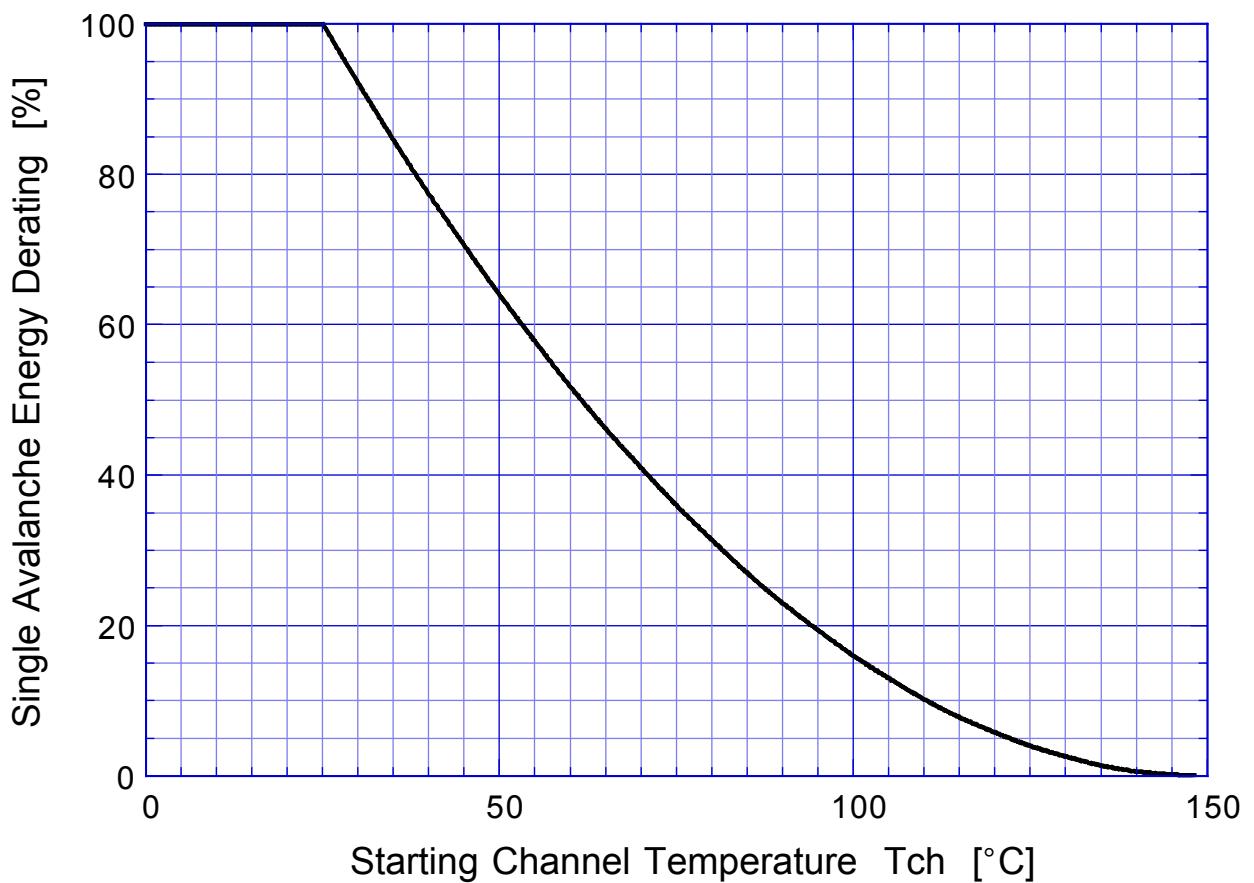
## 2SK2669 Safe Operating Area



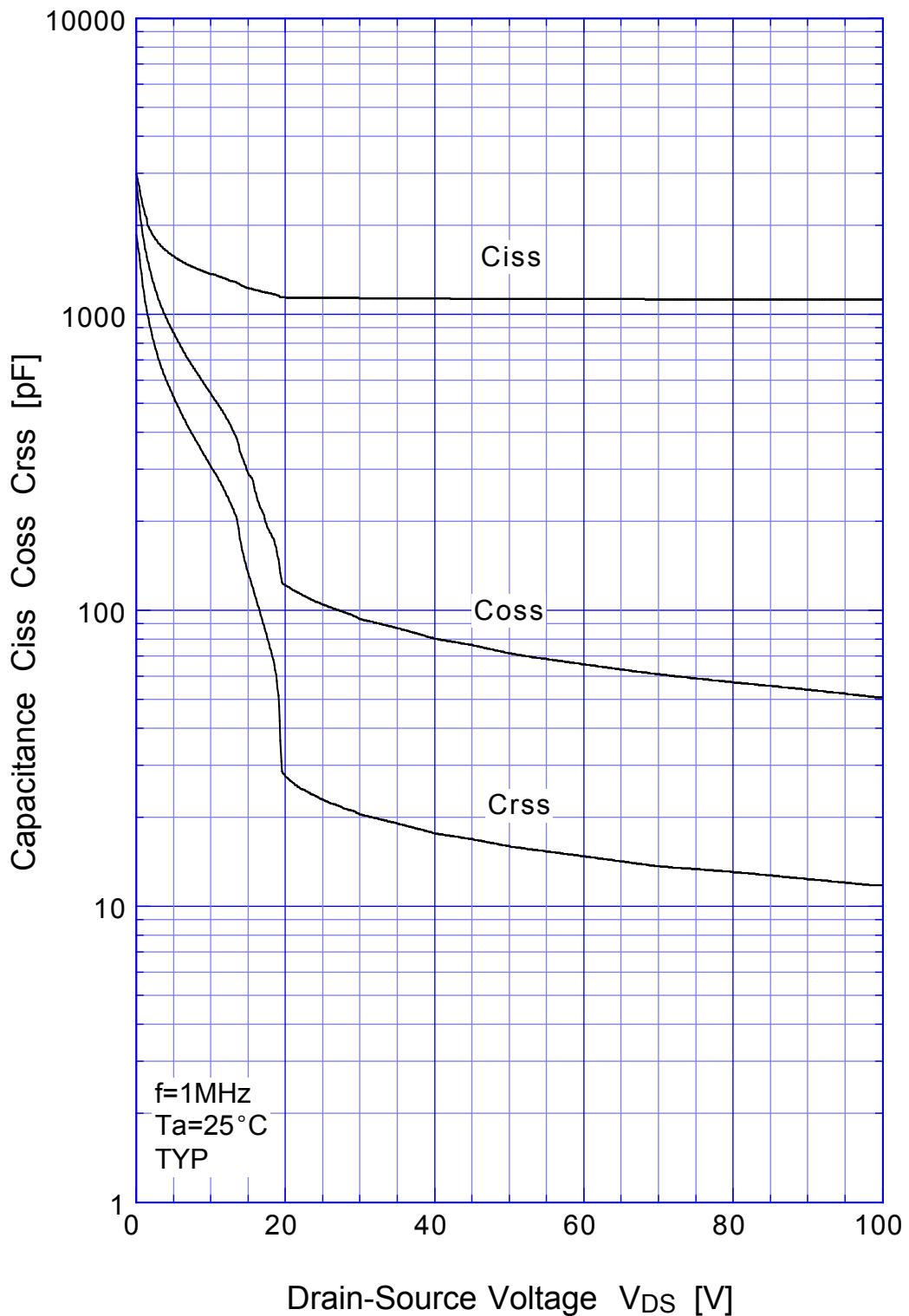
## 2SK2669 Transient Thermal Impedance



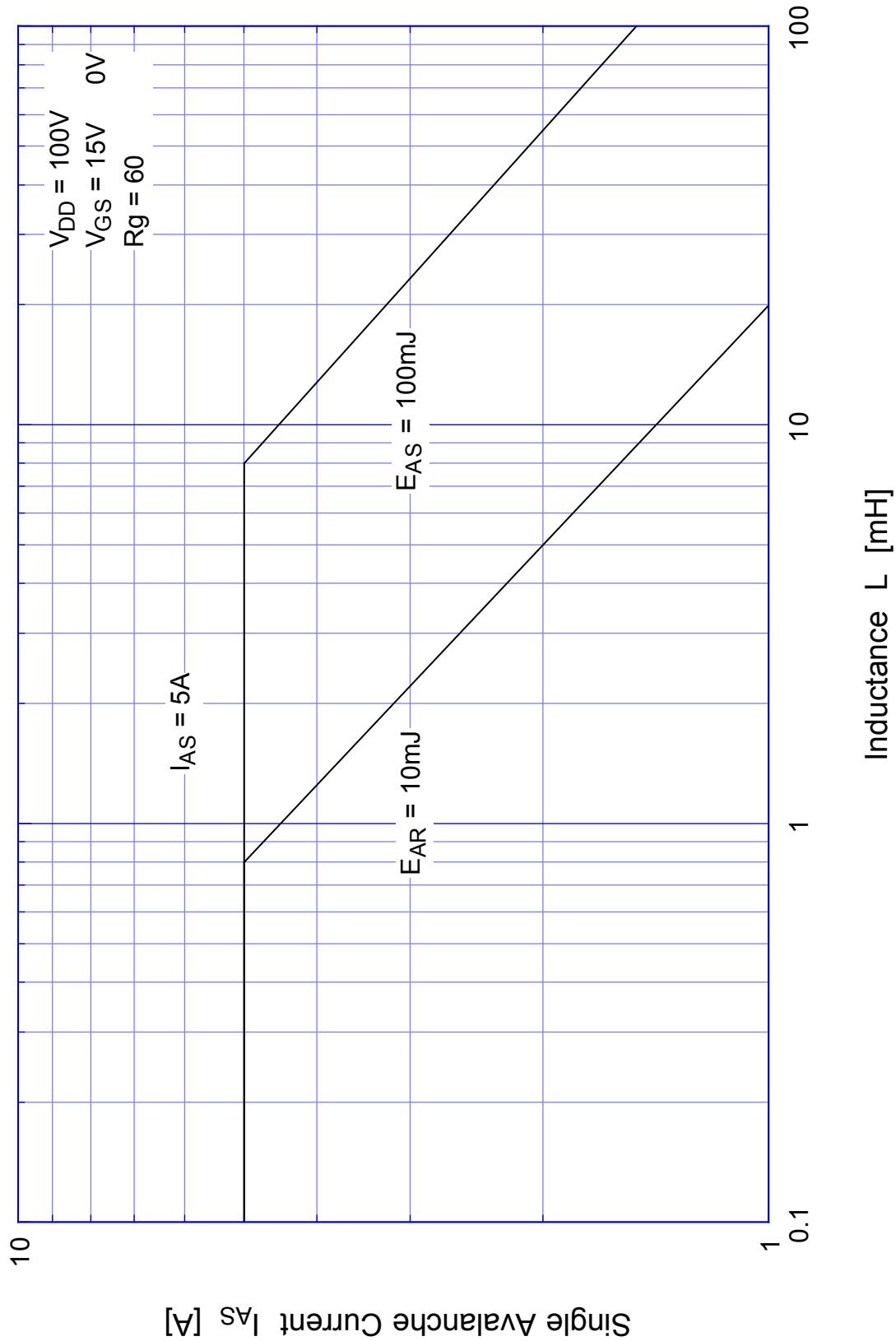
## **2SK2669 Single Avalanche Energy Derating**



2SK2669 Capacitance

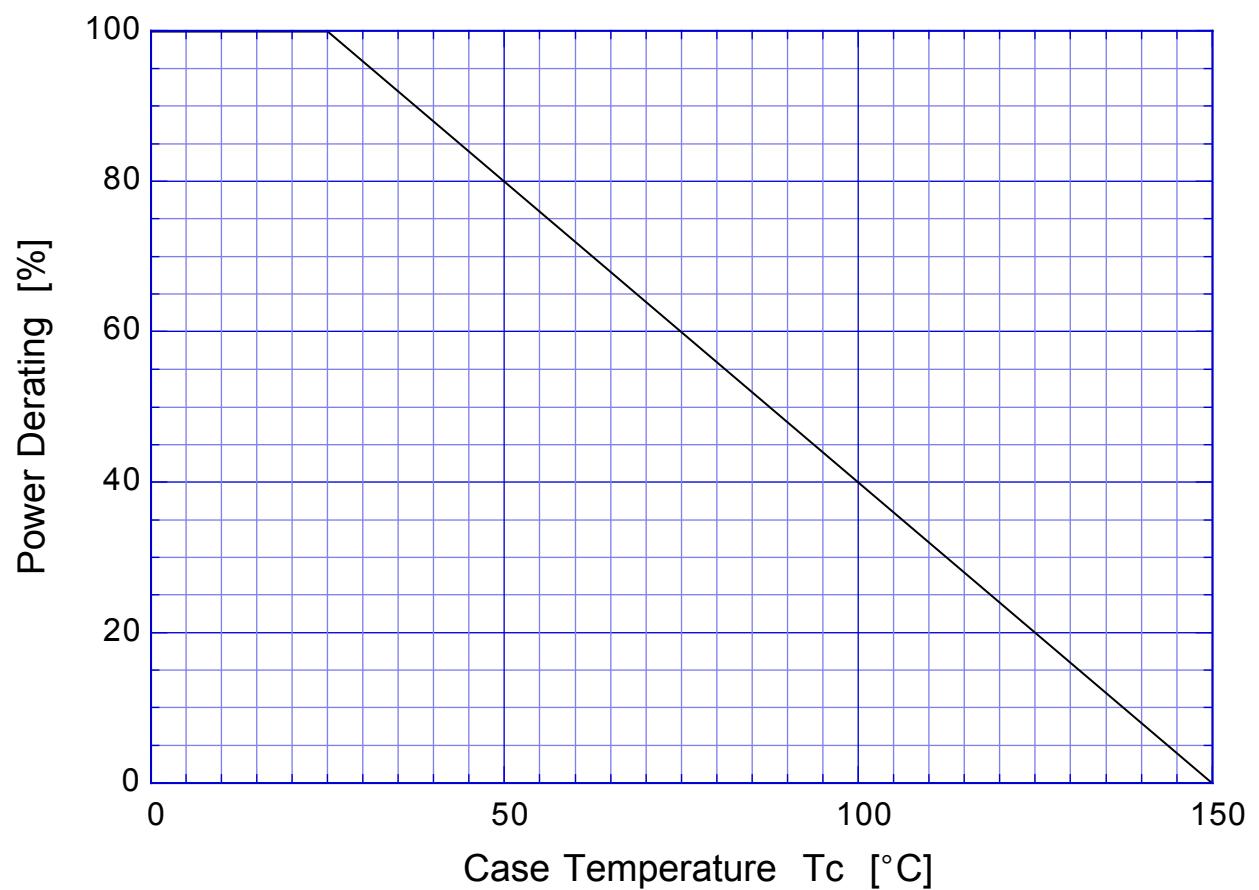


## 2SK2669 Single Avalanche Current - Inductive Load



**2SK2669**

Power Derating



## 2SK2669

### Gate Charge Characteristics

